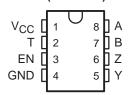
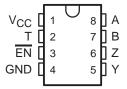
- Meets EIA Standards RS-422-A and RS-485 and CCITT Recommendations V.11 and X.27
- Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments
- 3-State Outputs
- Bus Voltage Range . . . –7 V to 12 V
- Positive and Negative Current Limiting
- Driver Output Capability . . . 60 mA Max
- Driver Thermal Shutdown Protection
- Receiver Input Impedance . . . 12 kΩ Min
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Input Hysteresis . . . 50 mV Typ
- Operates From Single 5-V Supply
- Low Power Requirements

SN75177B . . . D OR P PACKAGE (TOP VIEW)



SN75178B . . . P PACKAGE (TOP VIEW)



THE SN75177B IS NOT RECOMMENDED FOR NEW DESIGN

description

The SN75177B and SN75178B differential bus repeaters are monolithic integrated devices each designed for one-way data communication on multipoint bus transmission lines. These devices are designed for balanced transmission bus line applications and meet EIA Standard RS-422-A and RS-485 and CCITT Recommendations V.11 and X.27. Each device is designed to improve the performance of the data communication over long bus lines. The SN75177B and SN75178B are identical except for the complementary enable inputs, which allow the devices to be used in pairs for bidirectional communication.

The SN75177B and SN75178B feature positive- and negative-current limiting 3-state outputs for the receiver and driver. The receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ± 200 mV over a common-mode input voltage range of -7 V to 12 V. The driver features thermal shutdown for protection from line fault conditions. Thermal shutdown is designed to occur at a junction temperature of approximately 150°C. The driver is designed to drive current loads up to 60 mA maximum.

The SN75177B and SN75178B are designed for optimum performance when used on transmission buses employing the SN75172 and SN75174 differential line drivers, SN75173 and SN75175 differential line receivers, or SN75176B bus transceiver.

Function Tables

SN75177B

DIFFERENTIAL INPUTS	ENABLE	OUTPUTS		
A – B	EN	T	Υ	Z
V _{ID} ≥ 0.2 V	Н	Н	Н	L
$-0.2 \text{ V} < \text{V}_{\text{1D}} < 0.2 \text{ V}$	Н	?	?	?
V _{ID} ≤ 0.2 V	Н	L	L	Н
X	L	Z	Z	Z

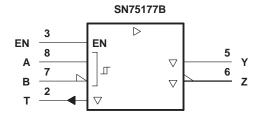
SN75178B

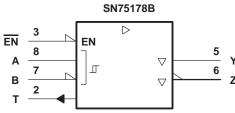
DIFFERENTIAL INPUTS	ENABLE			
A – B	EN	Т	Υ	Z
V _{ID} ≥ 0.2 V	L	Н	Н	L
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	L	?	?	?
V _{ID} ≤ 0.2 V	L	L	L	Н
X	Н	Z	Z	Z

H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = impedance (off)



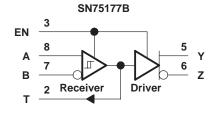
logic symbols†

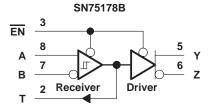




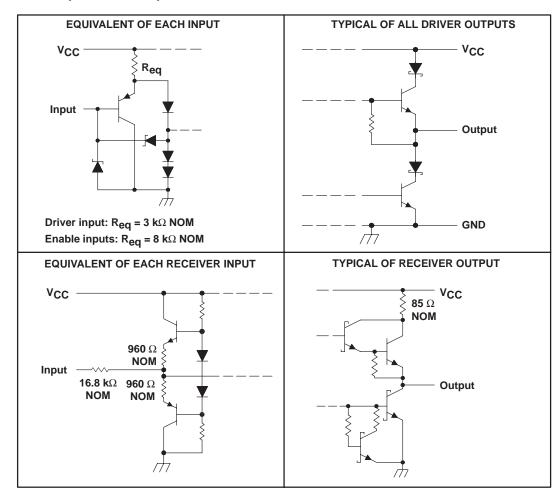
† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagrams (positive logic)





schematics of inputs and outputs



SLLS002C - D2606, JULY 1985 - REVISED FEBRUARY 1993

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

7 V
−10 V to 15 V
±25 V
See Dissipation Rating Table
0°C to 70°C
–65°C to 150°C
260°C

NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.

2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING
D	725 mW	5.8 mW/°C	464 mW
Р	1000 mW	8.0 mW/°C	640 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
High-level input voltage, VIH	EN or EN	2			V
low-level input voltage, V _{IL}	EN or EN			0.8	V
Common-mode input voltage, V _{IC}		_7 [†]		12	V
Differential input voltage, V _{ID}				±12	V
High level output ourrent leve	Driver			-60	mA
High-level output current, IOH	Receiver			-400	μΑ
Low lovel output ourrent I	Driver			60	mA
Low-level output current, IOL	Receiver			8	ША
Operating free-air temperature, TA		0		70	°C

[†] The algebraic convention, where the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage.

DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CO	TEST CONDITIONS		TYP [†]	MAX	UNIT
VIK	Input clamp voltage	I _I = -18 mA				-1.5	V
٧o	Output voltage	IO = 0		0		6	V
V _{OD1}	Differential output voltage	I _O = 0		1.5		6	V
VOD2	Differential output voltage	$R_L = 100 \Omega$,	See Figure 1	1/2 V _{OD1} or 2§			V
		$R_L = 54 \Omega$,	See Figure 1	1.5	2.5	5	
VOD3	Differential output voltage	See Note 3		1.5		5	V
$\Delta V_{OD} $	Change in magnitude of diferential output voltage‡	B 54.0 × 400.0	One Figure 4			±0.2	V
Voc	Common-mode output voltage	$R_L = 54 \Omega \text{ or } 100 \Omega,$	$R_L = 54 \Omega$ or 100 Ω , See Figure 1			3 -1	V
Δ V _{OC}	Change in magnitude of common-mode output voltage‡					±0.2	٧
lo	Output current	$V_{CC} = 0$,	$V_0 = -7 \text{ V to } 12 \text{ V}$			±100	μΑ
loz	High-impedance-state output current	$V_0 = -7 \text{ V to } 12 \text{ V}$				±100	μΑ
lіН	High-level input current	V _I = 2.4 V				20	μΑ
Iμ	Low-level input current	V _I = 0.4 V				-400	μΑ
		V _O = -7 V	V _O = -7 V			-250	
los	Short-circuit output current	VO = VCC	$V_{O} = V_{CC}$			250	mA
		V _O = 12 V				250	
loo	Supply surrent (total package)	No load	Outputs enabled		57 70		mA
ICC	Supply current (total package)	INUIUAU	Outputs disabled		26	35	IIIA

[†] All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

NOTE 3: See Figure 3.5 of EIA Standard RS-485.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER TEST CONDITIONS			MIN	TYP	MAX	UNIT
t _{dD}	Differential-output delay time	$R_1 = 54 \Omega$	See Figure 3		15	20	ns
t _{tD}	Differential-output transition time	KL = 54 12,	See rigule 3		20	30	ns
tPZH	Output enable time to high level	$R_L = 110 \Omega$,	See Figure 4		85	120	ns
tPZL	Output enable time to low level	$R_L = 110 \Omega$,	See Figure 5		40	60	ns
^t PHZ	Output disable time from high level	$R_L = 110 \Omega$,	See Figure 4		150	250	ns
tPLZ	Output disable time from low level	$R_L = 110 \Omega$,	See Figure 5		20	30	ns

[‡]Δ|V_{OD}| and Δ|V_{OC}| are the changes in magnitude of V_{OD} and V_{OC}, respectively, that occur when the input is changed from a high level to a low level

[§] The minimum V_{OD2} with a 100- Ω load is either 1/2 V_{OD1} or 2, whichever is greater.

SYMBOL EQUIVALENTS

DATA SHEET PARAMETER	RS-422-A	RS-485
Vo	V _{oa,} V _{ob}	V _{oa} , V _{ob}
IVOD1I	Vo	V _O
IV _{OD2} I	$V_t (R_L = 100 \Omega)$	$V_t (R_L = 54 \Omega)$
V _{OD3}		V _t (Test Termination) Measurement 2)
Δ V _{OD}	$ V_t - \overline{V}_t $	$ V_t - \overline{V}_t $
Voc	V _{OS}	V _{OS}
Δ VOC	V _{OS} − V _{OS}	V _{OS} − V _{OS}
los	I _{sa} , I _{sb}	
lo	l _{xa} , l _{xb}	l _{ia} ,l _{ib}

RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CO	NDITIONS	MIN	TYP†	MAX	UNIT
V _{T+}	Positive-going input threshold voltage	V _O = 2.7 V,	$I_0 = -0.4 \text{ mA}$			0.2	V
V _T _	Negative-going input threshold voltage	$V_0 = 0.5 V$,	IO = 8 mA	-0.2‡			V
V _{hys}	Input hysteresis (V _{T+} - V _{T-})				50		mV
VIK	Input clamp voltage at EN	$I_{I} = -18 \text{ mA}$				-1.5	V
Vон	High-level output voltage	V _{ID} = 200 mV, See Figure 2	$I_{OH} = -400 \mu A,$	2.7			V
VOL	Low-level output voltage	V _{ID} = -200 mV, See Figure 2	I _{OL} = 8 mA,			0.45	V
	High impedance state output ourrent	to entered sourced				20	
loz	High-impedance-state output current	$V_0 = 0.4 \text{ V to } 2.4 \text{ V}$				-400	μΑ
Ī	Line input ourrent	Other input at 0 V,	V _I = 12 V			1	m A
l II	Line input current	See Note 4	V _I = −7 V			-0.8	mA
lіН	High-level enable-input current	V _{IH} = 2.7 V				20	μΑ
I _I L	Low-level enable-input current	V _{IL} = 0.4 V				-200	μΑ
rį	Input resistance			12			kΩ
Ios	Short-circuit output current			-15		-85	mA
loo	Supply current (total package)	No load	Outputs enabled		57	70	mA
Icc	Supply surrent (total package)	TVOTOGG	Outputs disabled		26	35	111/4

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

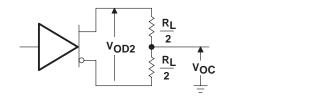
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low-to-high level output	$V_{ID} = -1.5 \text{ V to } 1.5 \text{ V},$		19	35	20
tPHL	Propagation delay time, high-to-low level output	C _L = 15 pF, See Figure 6		30	40	ns
^t PZH	Output enable time to high level	C. 45 pF Coo Figure 7		10	20	
tPZL	Output enable time to high level	C _L = 15 pF, See Figure 7		12	20	ns
^t PHZ	Output disable time from high level	C. – 15 pF Soo Figure 9		25	35	20
tPLZ	Output disable time from low level	C _L = 15 pF, See Figure 8		17	25	ns



[‡] The algebraic convention, where the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

NOTE 4: Refer to EIA Standard RS-422 for exact conditions.

PARAMETER MEASUREMENT INFORMATION



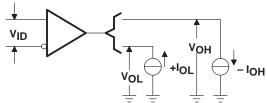


Figure 1. Driver V_{OD} and V_{OC}

Figure 2. Receiver VOH and VOL

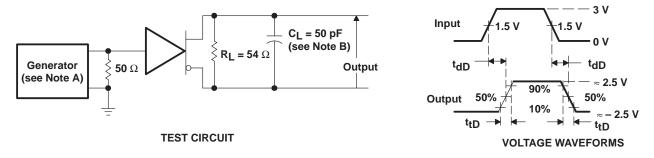


Figure 3. Driver Differential-Output Test Circuit and Voltage Waveforms

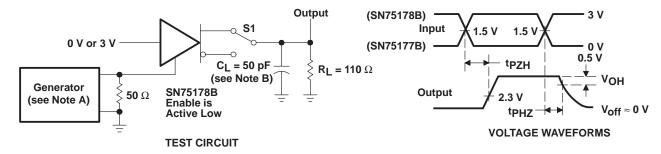


Figure 4. Driver Enable and Disable Times

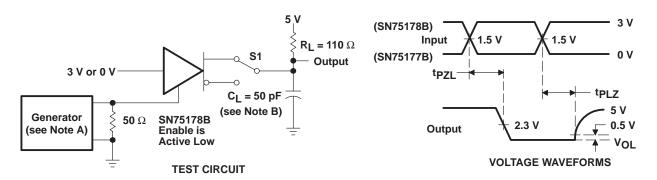


Figure 5. Driver Enable and Disable Times

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_{f} \leq$ 6 ns, $t_{f} \leq$ 7 ns, $t_{f} \leq$ 8 ns, $t_{f} \leq$ 8 ns, $t_{f} \leq$ 9 ns, $t_$

B. CL includes probe and jig capacitance.



PARAMETER MEASUREMENT INFORMATION

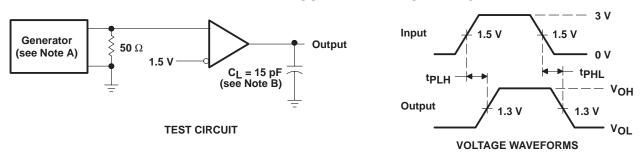


Figure 6. Receiver Propagation Delay Times

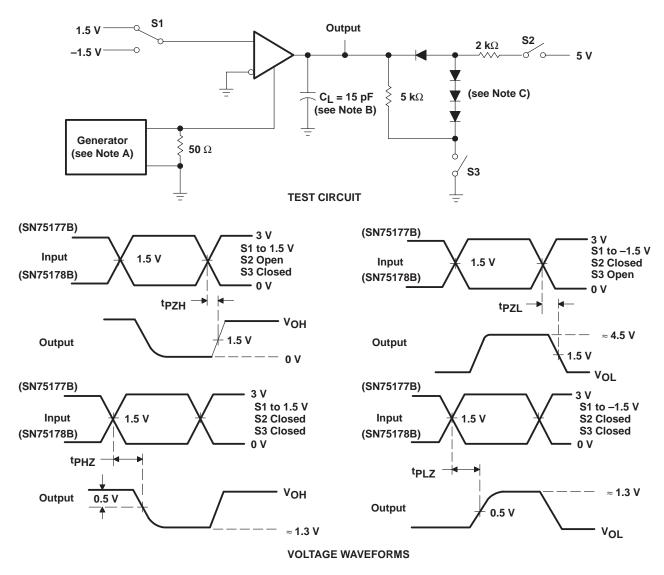


Figure 7. Receiver Output Enable and Disable Times

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_{\Gamma} \leq$ 6 ns, $t_{\Gamma} \leq$ 7 ns, $t_{\Gamma} \leq$ 8 ns, $t_{\Gamma} \leq$ 9 ns, $t_$

- B. C_L includes probe and jig capacitance.
- C. All diodes are 1N916 or equivalent.



TYPICAL CHARACTERISTICS

DRIVER HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

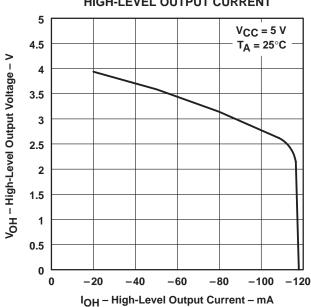


Figure 8

5 $V_{CC} = 5 V$ 4.5 T_A = 25°C VOH - High-Level Output Voltage - V 3.5 3 2.5 2 1.5 1 0.5 0 0 20 40 60 80 100 120 IOH - Low-Level Output Current - mA

DRIVER LOW-LEVEL OUTPUT VOLTAGE

LOW-LEVEL OUTPUT CURRENT

Figure 9

DRIVER DIFFERENTIAL OUTPUT VOLTAGE

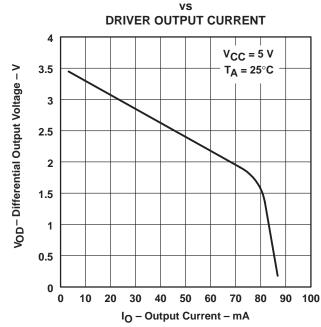


Figure 10

RECEIVER OUTPUT VOLTAGE vs DIFFERENTIAL INPUT VOLTAGE

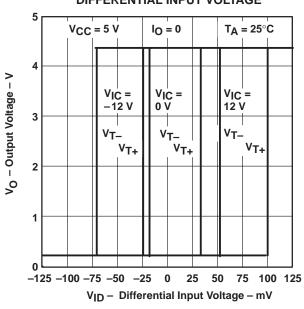


Figure 11

TYPICAL CHARACTERISTICS

RECEIVER HIGH-LEVEL OUTPUT VOLTAGE

HIGH-LEVEL OUTPUT CURRENT

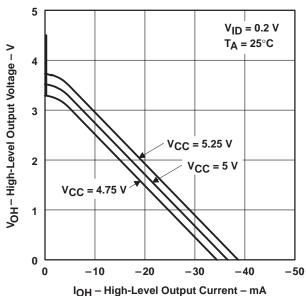


Figure 12

RECEIVER LOW-LEVEL OUTPUT VOLTAGE

LOW-LEVEL OUTPUT CURRENT

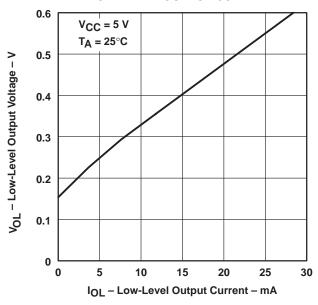


Figure 14

RECEIVER HIGH-LEVEL OUTPUT VOLTAGE vs

FREE-AIR TEMPERATURE

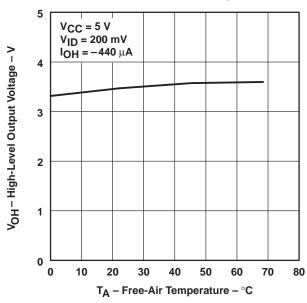


Figure 13

RECEIVER LOW-LEVEL OUTPUT VOLTAGE vs

FREE-AIR TEMPERATURE

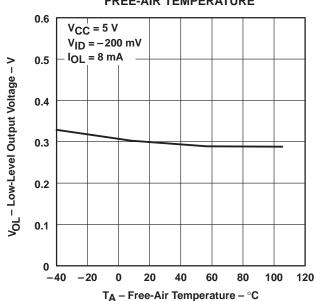
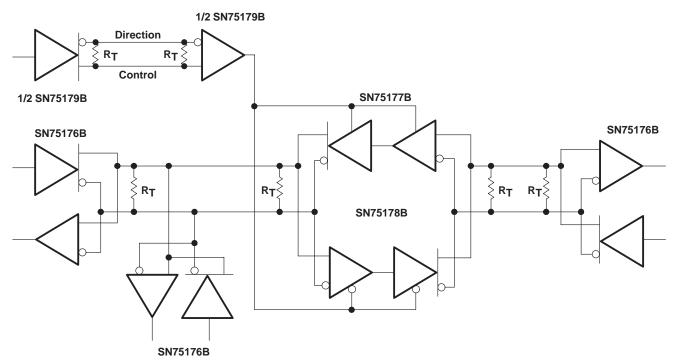


Figure 15

APPLICATION INFORMATION



NOTE: The line should be terminated at both ends in its characteristic impedance. Stub lengths off the main line should be kept as short as possible.

Figure 16. Typical Application Circuit







ii.com 24-Apr-2006

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN75177BD	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI
SN75177BP	OBSOLETE	PDIP	Р	8		TBD	Call TI	Call TI
SN75178BD	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI
SN75178BDR	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI
SN75178BP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75178BPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN75178BPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN75178BPSRE4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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